

Title (en)  
THERMOCURABLE ELECTROCONDUCTIVE ADHESIVE SHEET, CONNECTION STRUCTURE AND CONNECTION METHOD USING THE SAME

Title (de)  
WÄRMEVERNETZBARE, ELEKTRISCH LEITENDE KLEBEFOLIE, VERBINDUNGSSTRUKTUR UND DIE FOLIE VERWENDENDE VERBINDUNGSMETHODE

Title (fr)  
FEUILLE ADHESIVE THERMODURCISSABLE ELECTROCONDUCTRICE, STRUCTURE DE CONNEXION ET PROCEDE DE CONNEXION L'UTILISANT

Publication  
**EP 1315780 A2 20030604 (EN)**

Application  
**EP 01968695 A 20010907**

Priority  
• JP 2000273119 A 20000908  
• US 0128141 W 20010907

Abstract (en)  
[origin: WO0220686A2] A thermocurable electroconductive adhesive sheet which is able to make an electric connection having mechanical, thermal and electric stability, and low resistance, produced by a simple and easy process is provided.

IPC 1-7  
**C09J 7/02**; **C09J 5/06**; **H01R 4/04**

IPC 8 full level  
**B32B 3/30** (2006.01); **C09J 5/06** (2006.01); **C09J 7/28** (2018.01); **C09J 163/00** (2006.01); **C09J 171/10** (2006.01); **H01B 5/14** (2006.01); **H01B 17/62** (2006.01); **H01R 4/04** (2006.01); **H05K 3/32** (2006.01); **H05K 3/40** (2006.01)

CPC (source: EP KR US)  
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Citation (search report)  
See references of WO 0220686A2

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